

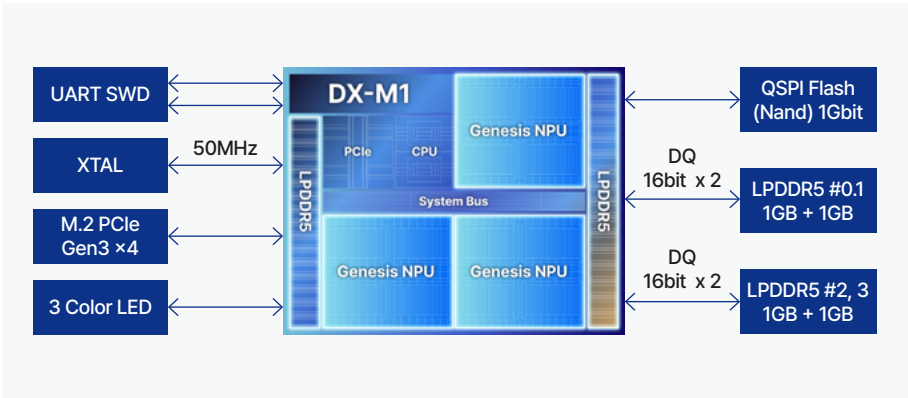
DX-M1 M.2 LPDDR5×2 for Every AIoT

The DEEPX DX-M1 M.2 module brings server-grade AI inference directly to edge devices. Delivering 25 TOPS of performance at just 2-5W, the module achieves 20x better performance efficiency (FPS/W) than GPGPUs while maintaining GPU-level AI accuracy.



“Integrating powerful AI vision processing and essential core features into a single chip, DEEPX drives innovative edge AI solutions for diverse intelligent systems.”

DX-M1 M.2 LPDDR5x2: Functional Block Diagram



Specifications

| Feature | AI Accelerator | Details |
|------------------|-------------------|--|
| Processor | INT8 Performance | 25 TOPS |
| Signal Interface | PCI Express | PCIe Gen.3 ×4 / Bandwidth: 4GB/s *Compatible to PCIE x1 |
| Power | Power Consumption | 2W min., 5W max. for DEEPX supported models |
| Operating | Temperature | -25 ~ 85°C (Throttling) -25 ~ 65°C (Non_Throttling) |
| Environment | Humidity | 40 °C @ 85% relative humidity (non-condensing) |
| Thermal Solution | Cooling | Heatsink (Option) |
| Physical | Form Factor | M.2 2280 (Key M) |
| | Dimensions | 22mm x 80mm x 4.1mm |
| | Power Range | 3.3V ± 5% |
| Software Support | Windows | Windows 11, 10 64 bit |
| | Linux | Ubuntu 22.04, 20.04 LTS Support Yocto Project and Docker |
| | Framework | Support TensorFlow, TensorFlow Lite, ONNX, Keras, PyTorch by Dataflow compiler converted |
| System Support | CPU Platform | x86, ARM Based Architecture |



Key Features

- > Type: AI Accelerator
- > Form Factor: M.2 M Key (22 × 80 mm)
- > Interface: PCIe Gen.3 ×4
- > Memory: 4GB LPDDR5, QSPI 1Gbit NAND Flash
- > Host HW: x86, ARM Based Architecture

Support DXNN® SDK

DXNN® SDK is a comprehensive SW development environment for deploying AI on DEEPX NPUs. It integrates tools for compiling, optimizing, simulating, and inferring the latest AI models, such as YOLO, ViT, and VLMs. And it provides an optimized, ready-to-use environment as the DX-AII Suite package to support fast and efficient AI development.

Target Applications

- 3D Sensing & Stereo Cameras
- AI NVR (Network Video Recorder)
- AI CCTV
- Robotics
- Automotive
- Video Conferencing Cameras
- CMS (Camera Monitoring System)
- Autonomous Robotic Platforms
- Drones
- AR/VR
- SBC (Single Board Computer)
- ADAS/AD

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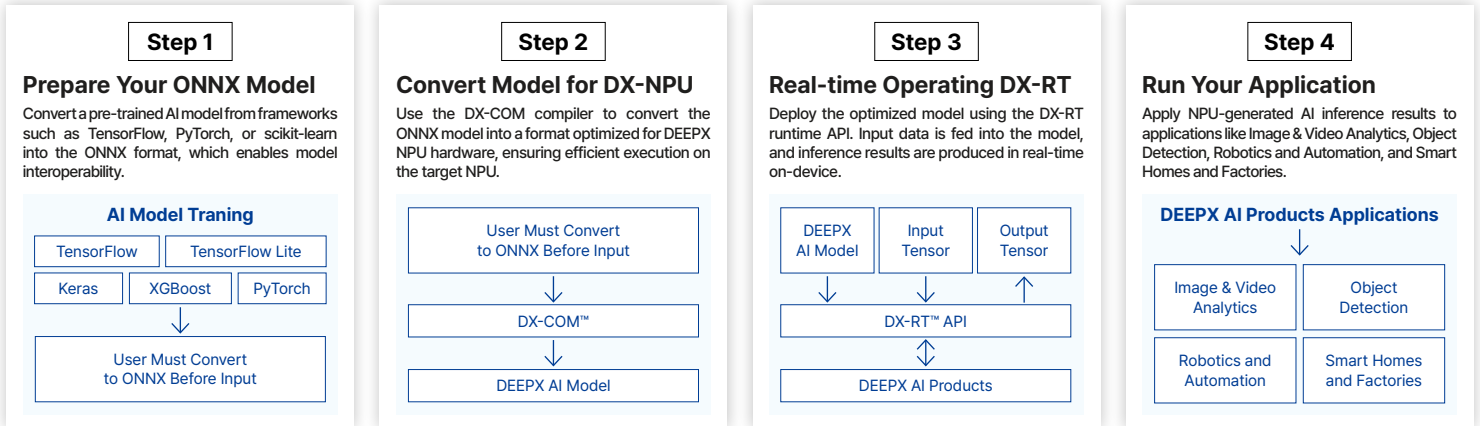
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DXNN® SDK

DXNN® (DEEPX Neural Network) SDK streamlines AI deployment on DEEPX NPUs by integrating version-aligned tools for compilation, optimization, simulation, and inference. For efficient development, it's offered as the DX-AS (All Suite), a fully integrated and optimized package.

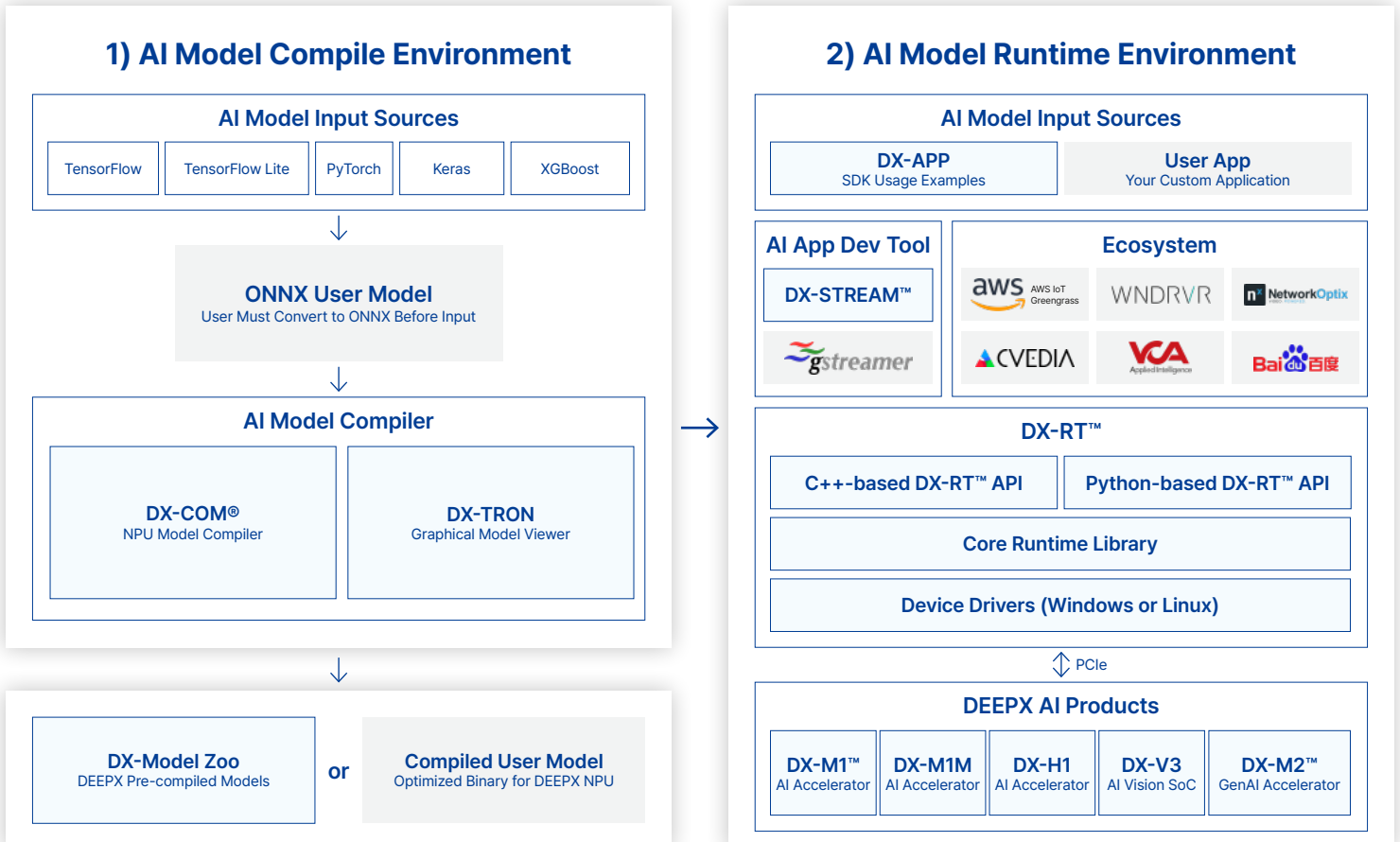


How It Works: 4-Step AI Deployment with DXNN® SDK



DXNN® Full Stack Architecture

DXNN® Full Stack Architecture streamlines AI model deployment onto DEEPX products using its two-stage AI Model Compile and Runtime Environments.



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